DISPLAY Elektronik GmbH

DATA SHEET

LCD MODULE

DEM 128064U SBH-PW-N

Product Specification

Version: 2

GENERAL SPECIFICATION

MODULE NO.:

DEM 128064U SBH-PW-N

CUSTOMER P/N

Version No.	Change Description	Date
0	Original Version	14.10.2020
1	Change to Parallel+ SPI Interface ;Add the BL lifetime	21.10.2020
2	Correct the "FSTN Blue" to "STN Blue" on page 2; Update the LCD drawing on page 13.	23.10.2020

PREPARED BY: CC DATE: 23.10.2020

APPROVED BY: MHI DATE: 23.10.2020

CONTENTS

1. FUNCTIONS & FEATURES	2
2. MECHANICAL SPECIFICATIONS	2
3. EXTERNAL DIMENSIONS	3
4. BLOCK DIAGRAM	4
5. PIN DESCRIPTION	5
6. BACKLIGHT ELECTRICAL/OPTICAL SPECIFICATIONS	6
7. MAXIMUM ABSOLUTE LIMIT	7
8. ELECTRICAL CHARACTERISTICS	7
9. INSTRUCTION DESCRIPTION	11
10 LCD LAYOUT	12
12. IC LAYOUT	14
14. MODULE ACCEPT QUALITY LEVEL (AQL)	14
15. RELIABILITY TEST	14
16. LCD MODULES HANDLING PRECAUTIONS	15
17. OTHERS	15

1. FUNCTIONS & FEATURES

I DEM 128064U Series LCD Type:

MODULE	LCD TYPE	REMARK
DEM 128064U SBH-PW-N	STN Blue Transmissive Negative Mode	

I Viewing Direction : 6 O'clock

I Driving Scheme : 1/64 Duty, 1/9Bias

Power Supply Voltage : 3.0VLCD Operation Voltage : 10V

I Display Contents : 128 x 64 dots

Interface : 8-bit-Parallel or SPI Interface

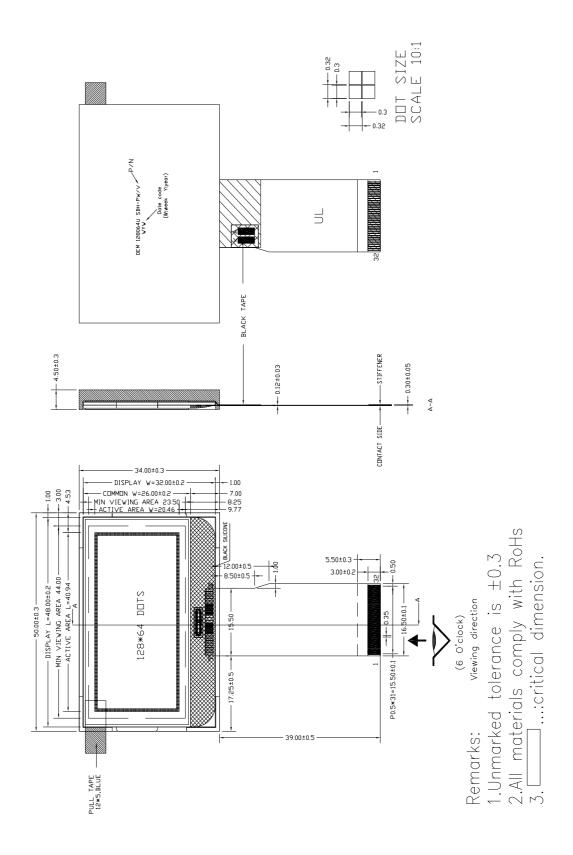
2. MECHANICAL SPECIFICATIONS

Module Size : 50.00 mm x 34.00 mm x 4.50mm

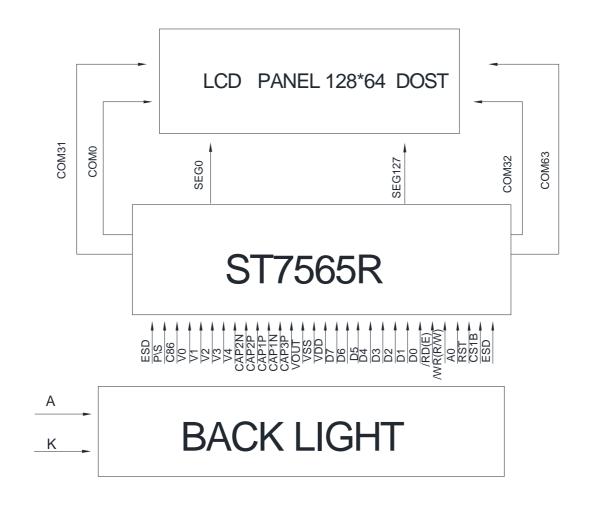
Viewing Area : 44.00 mm x 23.50 mm
 Active Area : 40.94 mm x 20.46 mm
 Dot Size : 0.30 mm x 0.30 mm

I Dot Gap : 0.02 mm

3. EXTERNAL DIMENSIONS



4. BLOCK DIAGRAM



5. PIN DESCRIPTION

Pin No.	Name	Description											
1	ESD	Ground											
		P/S = "H": Para P/S = "L": Seria	This pin configures the interface to be parallel mode or serial mode. P/S = "H": Parallel data input/output. P/S = "L": Serial data input. The following applies depending on the P/S status: P/S Data/Command Data Read/Write 4-line SPI Clock										
			P/S	Data/Command	Read/Write	4-line SPI Clock							
2	P/S		"H"	A0	D0 to D7	/RD, /WR	Х						
			"L"	A0	SI (D7)	Write only	SCL (D6)						
		/RD (E) and /W The serial acces	When P/S = "L", D0 to D5 must be fixed to "H". /RD (E) and MR (R/W) are fixed to either "H" or "L". The serial access mode does NOT support read operation.										
3	C86	This is the MPU C86 = "H": 6800 C86 = "L": 8080	Series	MPU interface.									
4	V0	This is a multi-	level po	wer supply for the I	liquid crystal	drive. The volta	age Supply applied	d is					
5	V1	determined by t	he liquid	crystal cell, and is	changed thro	ugh the use o	f a resistive voltage	e divided or					
6	V2			npedance using an ve magnitudes sho		Itage levels a	re determined base	ed on Vss, and					
7	V3			J	AMII DOIOM.								
8	V4	V ₀ ≦ VI ≦	$V_0 \ge V1 \ge V2 \ge V3 \ge V4 \ge Vss$										
9	CAP2N												
10	CAP2P												
11	CAP1P												
12	CAP1N	DC/DC voltage	convert	er.									
13	CAP3P												
14	VOUT												
15	VSS												
16	VDD	Power supply											
17	D7												
18	D6	This is an 8-bit l	bi-direct	ional data bus that	t connects to	an 8-bit or 16	-bit standard MPL	J					
19	D5	data bus.		(001.4): 1.4	1/0/0 "!!	n.							
20 21	D4 D3			e (SPI-4) is select I) ; D6 : the serial									
22	D3			nected to VDD or		JOL).							
23	D1	When the chip s	select is	not active, D0 to I	D7 are set to	high impedan	ice.						
24	D0												
25	/RD(E)	MPU and is LO The data bus is • When connect MPU and is HIG	W-active in an outed to 68 H-activ	utput status when t 300 series MPU, th	this signal is nis pin is trea	"L". ted as the "E"	-						
26	/WR(R/W)	When connecte MPU and is LO The signals on	d to 808 W-active the data ted to 68 es the a ": Read	so series MPU, this e. bus are latched a soo series MPU, th ccess type:	s pin is treate t the rising e	d as the "/WF	R signal.						
27	A0	This is connect determines whe A0 = "H": Indica	to the le ther the tes that	ast significant bit of data bits are data D0 to D7 are disp D0 to D7 are conti	or command lay data.		s bus, and it						
28	RST	When RST is se	A0 = "L": Indicates that D0 to D7 are control data. When RST is set to "L", the register settings are initialized (cleared). The reset operation is performed by the RST signal level.										

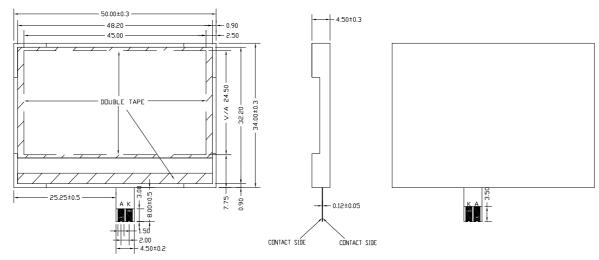
DEM 128064U SBH-PW-N

Product Specification

29	CS1B	This is the chip select signal. When CS1B = "L"							
30	ESD	Ground.							
31	A	Supply voltage for backlight LED+							
32	K	Supply voltage for backlight LED-							

6. BACKLIGHT ELECTRICAL/OPTICAL SPECIFICATIONS

Item	Symbol	min.	typ.	max.	Unit	Condition
Forward Voltage	Vf	2.6	3	3.4	V	If= 45 mA
Power Dissipation	Pd	_	_	153	mW	If= 45 mA
Luminous Uniformity	ΔLv	70			%	MIN/MAX*100%
Luminance	Lv		800		cd/m ²	If= 45 mA
	X	0.26		0.33		$T = 25^{\circ}C$
Color Coordinate	Y	0.23		0.30		
LED Lifetime				50000H		



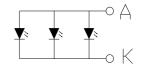
Remarks:

1.Unmarked tolerance is ± 0.2

2.<u>All materials</u> comply with RoHs

3. ...:critical dimension.

Circuit Diagram
Color: WHITE



7. MAXIMUM ABSOLUTE LIMIT

Characteristic	Symbol	Conditions	Unit
Power Supply Voltage	VDD	-0.3 ~ 3.6	V
Power Supply Voltage (VDD standard)	VDD2	-0.3 ~ 3.6	V
Power Supply Voltage (VDD standard)	V0, VOUT	-0.3 ~ 13.5	V
Power Supply Voltage (VDD standard)	V1, V2, V3, V4	-0.3 to V0	V
Operating Temperature	TOPR	-20 to +70	°C
Storage Temperature Bare chip	TSTR	-30 to +80	°C

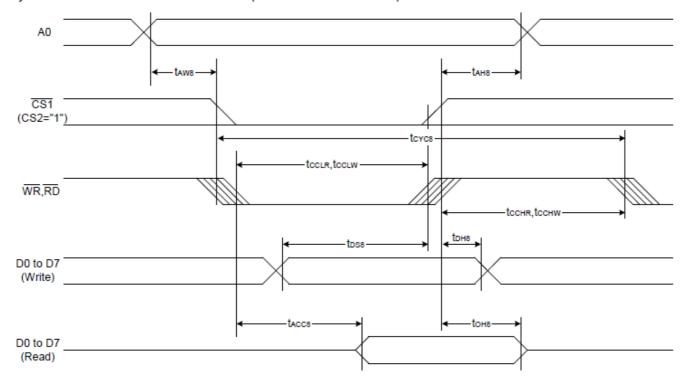
8. ELECTRICAL CHARACTERISTICS

8-1. DC Characteristics

Item	Symbol	Min	Тур	Max	Condition	Unit	Remark
Operating voltage	V_{DD}	2.7	3.0	3.3		V	
LCD driving voltage	V_{LCD}	9.7	10	10.3	-	V	
Operating current	I_{DD}		TBD			mA	

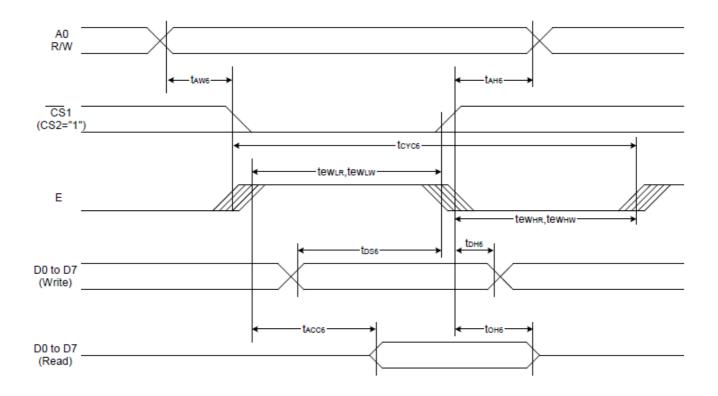
8-2. AC Characteristics

System Bus Read/Write Characteristics 1 (For the 8080 Series MPU)



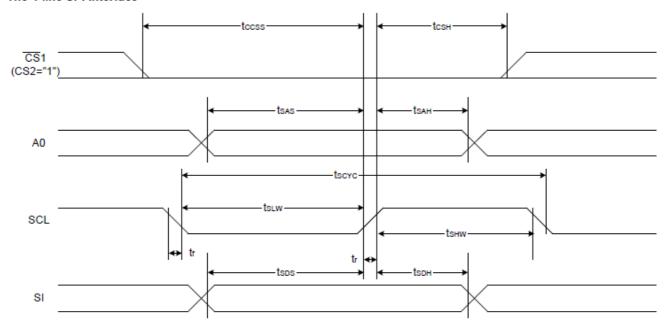
Item	Signal	Symbol	Condition	Rati	ing	Units
item	Signai	Symbol	Condition	Min.	Max.	Units
Address hold time		tah8		0	_	
Address setup time	A0	taws		0	_	
System cycle time		tcycs		240	_]
Enable L pulse width (WRITE)	WR	tccLw		80	_	
Enable H pulse width (WRITE)	WK	tсснw		80	_	
Enable L pulse width (READ)	RD	tcclr		140	_	Ns
Enable H pulse width (READ)	T KD	tcchr		80]
WRITE Data setup time		toss		40	_]
WRITE Address hold time	D0 to D7	tонв		0	_]
READ access time	001007	taccs	CL = 100 pF	_	70]
READ Output disable time		tонв	CL = 100 pF	5	50]

System Bus Read/Write Characteristics 2 (For the 6800 Series MPU)



Item	Signal Symbol		Condition	Rat	Units	
item	Signal	Symbol	Condition	Min.	Max.	Units
Address hold time		tah6		0	_	
Address setup time	A0	taw6		0	_	
System cycle time		tcyce		240	_	
Enable L pulse width (WRITE)	WR	tewLw		80	_	
Enable H pulse width (WRITE)	WK	tewnw		80	_	
Enable L pulse width (READ)	RD	tewlr		80	_	ns
Enable H pulse width (READ)	, KD	tewhr		140		
WRITE Data setup time		tose		40	_	
WRITE Address hold time	D0 to D7	tонв		0	_	
READ access time	ן ט ט ט ט	tacce	CL = 100 pF	_	70	
READ Output disable time		tонв	CL = 100 pF	5	50	

The 4-line SPI Interface



Item	Signal	Symbol	Condition	Rati	Units		
item	Signai	Symbol	Condition	Min.	Max.	Units	
4-line SPI Clock Period		Tscyc		50	_		
SCL "H" pulse width	SCL	SCL	Tshw		25	_	
SCL "L" pulse width]	TsLw		25	_]	
Address setup time	A0	Tsas		20	_]	
Address hold time	AU	Tsah		10	_	ns	
Data setup time	SI	T _{sds}		20	_]	
Data hold time	31	Тѕон		10	_]	
CS-SCL time	CS	Tess		20	_		
CS-SCL time	03	Tosh		40	_		

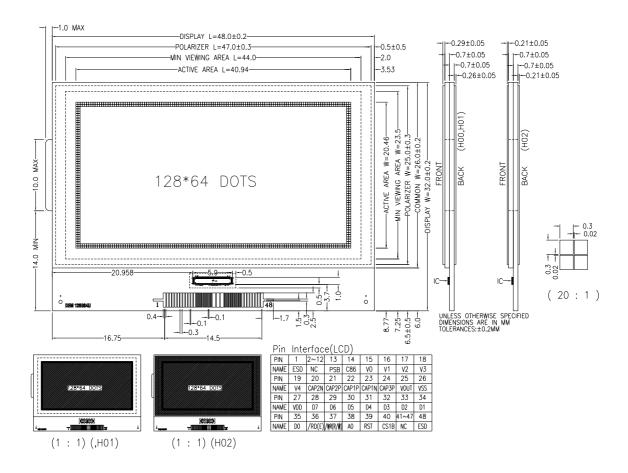
9. INSTRUCTION DESCRIPTION

Instruction Set

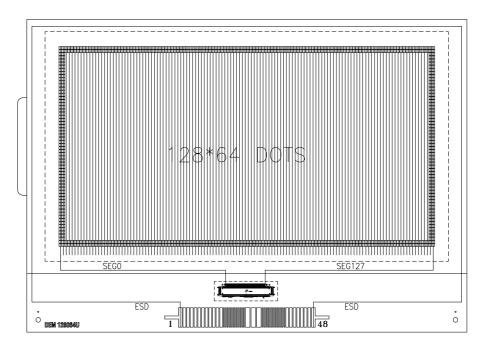
					Com	mano	l Cod	le				
Command	Α0	/RD	/WR	D7			D4		D2	D1	D0	Function
(1) Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0 1	LCD display ON/OFF 0: OFF, 1: ON
(2) Display start line set	0	1	0	0	1		Displ	ay st	art a	ddres	ss	Sets the display RAM display start line address
(3) Page address set	0	1	0	1	0	1	1	Р	age :	addre	ess	Sets the display RAM page address
(4) Column address set upper bit Column address set lower bit	0	1	0	0	0	0	1 0	co Le	lumn ast s	gnifi add ignifi add	ress cant	Sets the most significant 4 bits of the display RAM column address. Sets the least significant 4 bits of the display RAM column address.
(5) Status read	0	0	1		Sta	tus	-	0	0	0	0	Reads the status data
(6) Display data write	1	1	0					Wı	rite d	ata		Writes to the display RAM
(7) Display data read	1	0	1					Re	ad d	ata		Reads from the display RAM
(8) ADC select	0	1	0	1	0	1	0	0	0	0	0 1	Sets the display RAM address SEG output correspondence 0: normal, 1: reverse
(9) Display normal/ reverse	0	1	0	1	0	1	0	0	1	1	0	Sets the LCD display normal/ reverse 0: normal, 1: reverse
(10) Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0	0	Display all points 0: normal display 1: all points ON
(11) LCD bias set	0	1	0	1	0	1	0	0	0	1	0	Sets the LCD drive voltage bias ratio 0: 1/9 bias, 1: 1/7 bias (ST7565R)
(12) Read-modify-write	0	1	0	1	1	1	0	0	0	0	0	Column address increment At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write
(14) Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset
(15) Common output mode select	0	1	0	1	1	0	0	0	*	*	*	Select COM output scan direction 0: normal direction 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1	0	pera mod	_	Select internal power supply operating mode
(17) V ₀ voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Res	sistor	ratio	Select internal resistor ratio(Rb/Ra) mode
(18) Electronic volume mode set Electronic volume	0	1	0	1	0	0 E	0 lectro	0 onic v	0 olum	0 ne va	1 lue	Set the V ₀ output voltage electronic volume register
register set (19) Static indicator				1	0	1	0	1	1	0	0	0. OEE 1. ON
ON/OFF Static indicator	0	1	0								1	0: OFF, 1: ON Set the flashing mode
register set				0	. 0	. 0	. 0	0	0		Mode	select booster ratio
(20) Booster ratio set	0	1	0	1	1	1	1	1	0	0	0	00: 2x,3x,4x
	_		_	0	0	0	0	0	0		p-up alue	01: 5x 11: 6x
(21) Power save	0	1	0									Display OFF and display all points ON compound command
(22) NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation
(23) Test	0	1	0	1	1	1	1	*	*	*	*	Command for IC test. Do not use this command

10 LCD LAYOUT

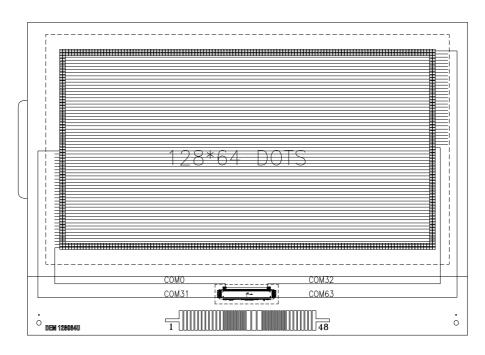
10-1. ARTWORK



10-3, SEG&COM LAYOUT

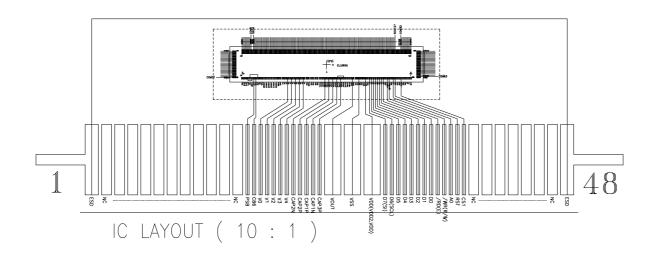


SEG LAYOUT



COM LAYOUT

12. IC LAYOUT



14. MODULE ACCEPT QUALITY LEVEL (AQL)

Inspection Plan: ANSI Z-1.4, Normal Inspection Level II, Single Sampling Plan.

15. RELIABILITY TEST

Operating life time: Longer than 50000 hours

(at room temperature without direct irradiation of sunlight)

Reliability characteristics shall meet following requirements.

	9 1
TEMPERATURE TESTS	NORMAL GRADE
High Temperature Storage	+80°C x 96hrs
Low Temperature Storage	-30°C x 96hrs
High Temperature Operation	+70°C x 96hrs
Low Temperature Operation	-20°C x 96hrs
High Temperature, High Humidity	+60°C x 90%RH x 96hrs
	(Without Polarizer)
Thermal Shock	-20°C x 30min 1 10s
Vibration Test	Frequency xSwing x Time 40Hz x 4mm x 4hrs
Drop Test	Drop height x Times 1.0m x 6times

16. LCD MODULES HANDLING PRECAUTIONS

The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc. If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.

Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.

To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- -Be sure to ground the body when handling the LCD module.
- -Tools required for assembly, such as soldering irons, must be properly grounded.
- -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0° C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

17. OTHERS

Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:

- Exposed area of the printed circuit board
- Terminal electrode sections